

## Master Bond EP21ANHT Two Component, Room Temperature Curing Epoxy Adhesive

Category: Polymer, Thermoset, Epoxy, Epoxy Encapsulant, Unreinforced

## **Material Notes:**

Product Description: Master Bond Polymer Adhesive EP21ANHT is a two component room temperature curing adhesive, sealant and coating that combines high thermal conductivity and electrical insulation properties, along with elevated temperature resistance. It has a forgiving one to one mix ratio by weight or volume. Although the system cures at room temperature, its physical properties are optimized by a post cure at 150°F for 2-3 hours. EP21ANHT adheres well to a wide variety of substrates including metals glass and many plastics. Its tensile shear strength exceeds 1,100 psi, enabling it to be used in many applications where high strength bonds are required. Other features include superior dimensional stability and a long working life. EP21ANHT offers good resistance to a wide range of chemicals including water, oil, fuels, and various solvents over the temperature range of -60°F to +400°F. The color of Part A is light gray; Part B is gray in color. EP21ANHT is widely used in electronic, electrooptical and related industries where excellent heat transfer and electrical insulation are required. Product Advantages: Convenient mixing: non-critical equal weight or volume ratio. Long working life. Easy application: contact pressure only required for cure; adhesive spreads evenly. Low coefficient of expansion, low shrinkage, superb dimensional stability.

Versatile cure schedules: ambient temperature cures or fast elevated temperature cures as required. High bonding strength to a wide variety of substrates. Good durability, thermal shock and chemical resistance. Great thermal conductivity; excellent electrical insulation properties. Information provided by MasterBond®

## Order this product through the following link:

http://www.lookpolymers.com/polymer\_Master-Bond-EP21ANHT-Two-Component-Room-Temperature-Curing-Epoxy-Adhesive.php

| Physical Properties | Metric             | English            | Comments |
|---------------------|--------------------|--------------------|----------|
| Viscosity           | 50000 - 110000 cP  | 50000 - 110000 cP  | Part B   |
|                     | 200000 - 600000 cP | 200000 - 600000 cP | Part A   |

| Mechanical Properties     | Metric               | English              | Comments       |
|---------------------------|----------------------|----------------------|----------------|
| Hardness, Shore D         | >= 85                | >= 85                |                |
| Tensile Strength at Break | 34.5 MPa             | 5000 psi             |                |
|                           | @Temperature 23.9 °C | @Temperature 75.0 °F |                |
| Tensile Modulus           | >= 3.45 GPa          | >= 500 ksi           |                |
|                           | @Temperature 23.9 °C | @Temperature 75.0 °F |                |
| Shear Strength            | >= 7.58 MPa          | >= 1100 psi          | Al/Al, tensile |

| Thermal Properties   | Metric              | English                                       | Comments |
|----------------------|---------------------|---|----------|
| CTE, linear          | 22.0 - 25.0 μm/m-°C | 12.2 - 13.9 μin/in-°F                         |          |
| Thermal Conductivity | 3.17 - 3.46 W/m-K   | 22.0 - 24.0 BTU-in/hr-<br>ft <sup>2</sup> -°F |          |



| Thermal Properties emperature, Air | Metric   | English  | Comments |  |
|------------------------------------|----------|----------|----------|--|
| Minimum Service Temperature, Air   | -51.1 °C | -60.0 °F |          |  |

| Electrical Properties | Metric                                     | English                                    | Comments |
|-----------------------|--|--|----------|
| Volume Resistivity    | >= 1.00e+13 ohm-cm                         | >= 1.00e+13 ohm-cm                         |          |
| Dielectric Constant   | 4.9  | 4.9  |          |
|                       | @Frequency 60.0 Hz,<br>Temperature 25.0 °C | @Frequency 60.0 Hz,<br>Temperature 77.0 °F |          |
| Dielectric Strength   | >= 15.7 kV/mm                              | >= 400 kV/in                               |          |
|                       | @Thickness 3.17 mm                         | @Thickness 0.125 in                        |          |

| Processing Properties | Metric               | English              | Comments                         |
|-----------------------|----------------------|----------------------|----------------------------------|
| Cure Time             | 120 - 180 min        | 2.00 - 3.00 hour     |                                  |
| Cure time             | @Temperature 93.3 °C | @Temperature 200 °F  |                                  |
|                       | 2880 - 4320 min      | 48.0 - 72.0 hour     |                                  |
|                       | @Temperature 23.9 °C | @Temperature 75.0 °F |                                  |
| Pot Life              | >= 90 min >= 90 min  |                      | 100 gram mass                    |
| Shelf Life            | 6.00 Month           | 6.00 Month           | in original, unopened containers |
|                       | @Temperature 23.9 °C | @Temperature 75.0 °F | in original, unopened containers |

| Descriptive Properties | Value | Comments            |
|------------------------|-------|---------------------|
| Mixing Ratio (A to B)  | 1:1   | by weight or volume |

## **Contact Songhan Plastic Technology Co.,Ltd.**

Website: www.lookpolymers.com Email: sales@lookpolymers.com

Tel: +86 021-51131842 Mobile: +86 13061808058 Skype: lookpolymers

Address: United North Road 215, Fengxian District, Shanghai City, China